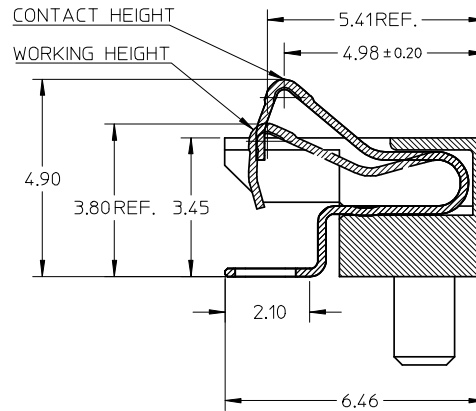
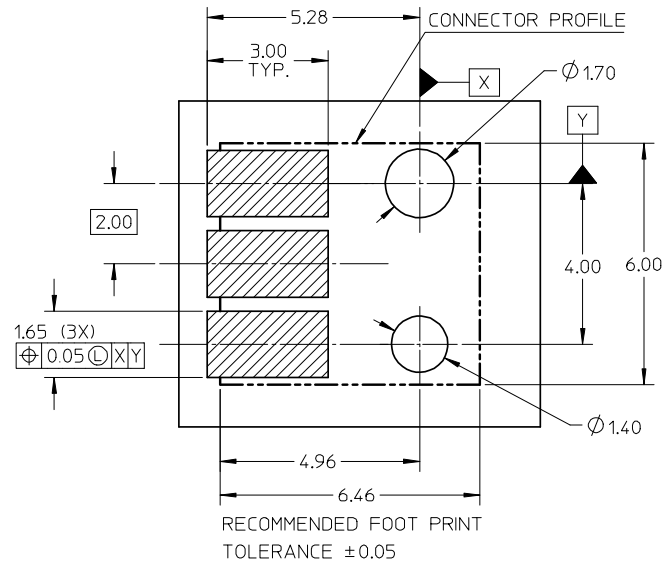
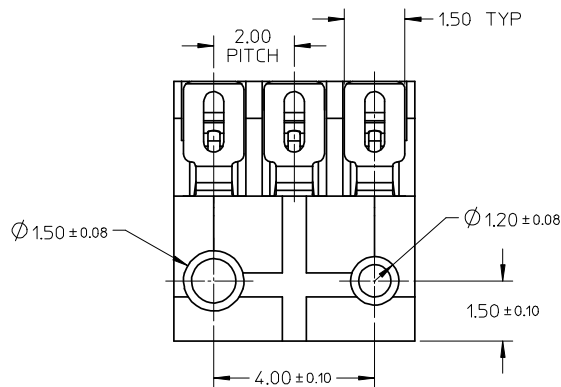
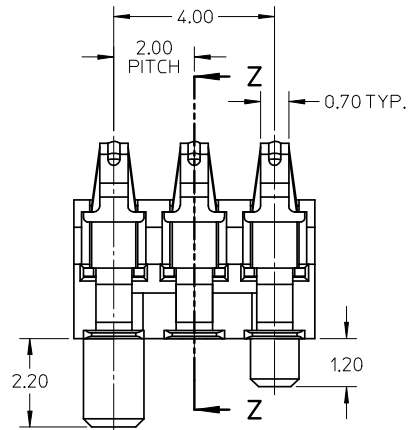
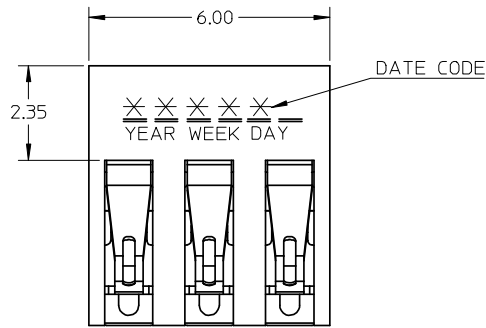
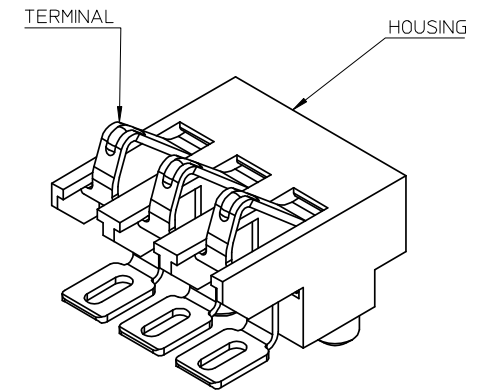




SECTION Z-Z



NOTE:

1.MATERIAL:

HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, COLOR: BLACK.
TERMINAL: COPPER ALLOY, THICKNESS 0.20MM.

2.FINISH:

CONTACT AREA: 0.75 MICRON GOLD MIN OVER 1.25 MICRON NICKEL MIN.
SOLDER AREA: GOLD FLASH OVER 1.25 MICRON NICKEL MIN.
REST AREA: 1.25 MICRON NICKEL MIN.

3.COPLANARITY: 0.1 MAX AMONG THESE SOLDER TAILS.

4.PRODUCT SPECIFICATION: PS-105040-001

RELEASED EC NO: SH2008-0623 DRWN: YWANG91 CHKD: YLZHU APPR: HWANG 2008/06/06 2008/06/06 2008/06/10	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 8:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION					
				mm	INCH	DRAWN BY YWANG	DATE 2008/03/12	TITLE 2.0MM PITCH 3 CIRCUITS BATTERY CONNECTOR						
			4 PLACES	± ---	± ---	CHECKED BY	DATE							
			3 PLACES	± ---	± ---	YLZHU	2008/03/12							
			2 PLACES	± 0.15	± ---	APPROVED BY	DATE	MOLEX INCORPORATED						
			1 PLACE	± 0.2	± ---	HWANG	2008/03/12							
			ANGULAR ± 2 °			MATERIAL NO. 1050400001							DOCUMENT NO. SD-105040-001	
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								
			A	REV										